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Murata Electronics North America ZRB18AR61A106ME01L

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Datasheet of ZRB18AR61A106ME01L - CAP CER 10UF 10V X5R 0603

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

Only Reflow Soldering

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Chip Monolithic Ceramic Capacitor on Interposer for General ZRB18AR61A106ME01_ (0603, X5R, 10uF, DC10V)

_: packaging code

Reference Sheet

1.Scope

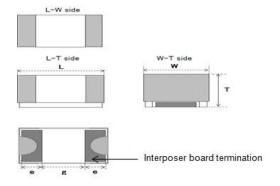
This product specification is applied to Chip Monolithic Ceramic Capacitor on Interposer used for General Electronic equipment.

This product is applied for Only Reflow Soldering.

2.MURATA Part NO. System

(Ex.)	ZRB	18	Α	R6	1A	106	М	E01	L
		(1)L/W Dimensions	(2)T Dimensions	(3)Temperature Characteristics	(4)DC Rated Voltage	(5)Nominal Capacitance	(6)Capacitance Tolerance	(7)Murata's Control Code	(8)Packaging Code

3. Type & Dimensions



(Unit:mm)

				()
(1)-1 L	(1)-2 W	(2) T	е	g
1.6±0.2	0.8±0.2	1.0±0.2	0.2 to 0.65	0.6 min.

4.Rated value

(3) Temperature (Public STD C	(4) DC Rated	(5) Nominal	(6) Capacitance	Specifications and Test Methods	
Temp. coeff or Cap. Change	Temp. Range (Ref.Temp.)	Voltage	Capacitance	Tolerance	(Operating Temp. Range)
-15 to 15 %	-55 to 85 °C (25 °C)	10 Vdc	10 uF	±20 %	-55 to 85 °C

5.Package

mark	(8) Packaging	Packaging Unit
L	φ180mm Reel EMBOSSED W8P4	3000 pcs./Reel

Product specifications in this catalog are as of May.25,2014,and are subject to change or obsolescence without notice. Please consult the approval sheet before ordering.

Please read rating and !Cautions first.



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■SPECIFICATIONS AND TEST METHODS

No	Item	Specification	Test Method		
	Operating	R6 : -55°C to 85°C	Standard Temperature : 25°C		
	Temperature Range				
2	Rated Voltage	See the previous pages.	The rated voltage is defined as the maximum voltage which may be applied continuously to the capacitor. When AC voltage is superimposed on DC voltage, V ^{P-P} or V ^{C-P} , whichever is larger, should be maintained within the rated voltage range.		
3	Appearance	No defects or abnormalities.	Visual inspection.		
4	Dimension	Within the specified dimensions.	Using calipers.		
5	Dielectric Strength	No defects or abnormalities.	Test Voltage :Rated voltagex250% Time : 1 to 5s Charge Current : 50mA max. To apply the test voltge through the Interposer board termination.		
6	Insulation Resistance	More than 50Ω · F	Voltage: Rated voltage Time: 1 min Charge Current: 50mA max. To apply the test voltge through the Interposer board termination.		
7	Capacitance	Within the specified tolerance.	The capacitance should be measured at Standard Temperature at the frequency and voltage shown in the table.		
8	Dissipation Factor (D.F.)	R6: 0.1 max.	The D.F. should be measured at Standard Temperature at the Frequency and voltage shown in the table.		
9	Capacitance Temperature Characteristics	R6 : Within ±15% (-55°C to +85°C)	The capacitance change should be measured after 5min. at each specified temp.stage. In case of applying voltage, the capacitance change should be measured after 1 more min. Measurement Voltage ZRB18A R6 1A 106M: 0.2±0.05Vms Test Conditions		
			Step Temperature(°C) Applying voltage(V)		
			1 25±2(for R6) 2 -55±3(for R6) 3 25±2(for R6) 4 85±3(for R6)		
10	Adhesive Strength of	No removal of the terminations or other defect should occur.	To apply the test voltge through the Interposer board termination. Initial measurement Perform a heat treatment at 150+0/-10°C for one hour and then set at room temperature for 24±2 hours. Perform the initial measurement. Solder the capacitor on the test jig shown in Fig.3 using an solder.		
	Termination		Applying Force(F): 5N Applying time: 10±1s		



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■ SPECIFICATIONS AND TEST METHODS

No		em	Specification	Test Method			
11	Vibration Resistance	Appearance	No defects or abnormalities.	Solder the capacitor on the test jig shown in Fig.3 using			
		Capacitance	Within the specified tolerance.	Oscillation Frequency: A 10Hz to 55Hz to 10Hz for 1 min Total Amplitude 1.5mm			
		D.F.	R6: 0.1 max.	A period of 2 hours in each of 3 mutually perpendicular directions. (Total 6 h)			
12	Deflection	Appearance	No defects or abnormalities.	Test Method : According to Fig1,Fig2			
		Capacitance	Within ±10%	Deflection : 1mm Keeping Time : 5±1s			
13	Solderability of	Change f	75% of the terminations is to be soldered evenly	Mounting Method: Reflow soldering Test Conditions: solder bath method, method 1			
	Interposer board termination		and continuously.	Solder : Sn-3.0Ag-0.5 Cu solder Solder Temperature : 245±5°C Immersion Time : 2±0.5s			
14	Resistance to Soldering Heat	Appearance	No defects or abnormalities.	Test Conditions : Reflow method Solder : Sn-3.0Ag-0.5 Cu solder			
		Capacitance Change	R6 : Within ±7.5%	Solder Temperature : 255°C ±10°C[Peak Temperature] Heat Time of over 200°C : 120s min			
		D.F.	R6: 0.1 max.	Exposure to room temperature : 24±2h Pre-heat : Following conditions Table1			
		I.R.	More than 50Ω · F	Temperature Time			
				150°C to 160°C 2 min.			
		Dielectric Strength	No defects.	 Initial measurement Perform a heat treatment at 150+0/-10°C for one hour and then set at roon temperature for 24±2 hours. Perform the initial measurement. 			
15	Temperature Sudden	Appearance	No defects or abnormalities.	Solder the capacitor on the test jig shown in Fig.3 using			
	Change	Capacitance Change	R6 : Within ±7.5%	Total of 5 cycles Step Temp.(°C) Time (min)			
				1 Min. 30±3 Operating Temp.+0/-3			
		D.F.	R6 : 0.1 max.	2 Room Temp 2 to 3			
				3 Max. 30±3 Operating Temp.+3/-0			
				4 Room Temp 2 to 3 Exposure to room temperature : 24±2 h			
		I.R.	More than $50\Omega \cdot F$	Initial measurement Perform a heat treatment at 150+0/-10°C for one hour and then set at room temperature for 24±2 hours.			
		Dielectric Strength	No defects.	Perform the initial measurement.			
16	High	Appearance	No defects or abnormalities.	Temperature : 40±2°C			
	Temperature High	Capacitance	R6 : Within ±12.5%	Humidity: 90 to 95% Time: 500±12h Test Voltage: Rated voltage Charge Current: 50mA.			
	Humidity (Steady)	Change					
	(Oloudy)	D.F.	R6 : 0.2max.				
				 Initial measurement Perform a heat treatment at 150+0/-10°C for one hour and then let sit for 24±2 hours at room temperature. Perform the initial measurement. 			
		I.R.	More than 12.5Ω · F	Measurement after test Perform a heat treatment and then let sit for 24±2 hours at room temperature then measure.			
17	Durability	Appearance	No defects or abnormalities.	Temperature : Maximum operating temperature ±3°C Time : 1000±12h			
		Capacitance Change	R6 : Within ±12.5%	Test Voltage : Rated voltage×150% Charge Current : 50mA.			
	D.F. R6 : 0.2max.		R6: 0.2max.	 Initial measurement Perform a heat treatment at 150+0/-10°C for one hour and then let sit for 24±2 hours at room temperature. Perform the initial measurement. 			
		I.R.	More than $25\Omega \cdot F$	Measurement after test Perform a heat treatment and then let sit for 24±2 hours at room temperature, then measure.			



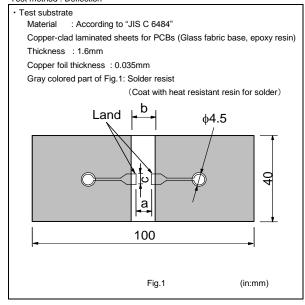
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■SPECIFICATIONS AND TEST METHODS

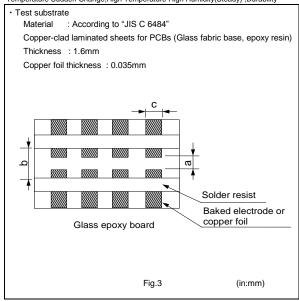
Test method : Deflection



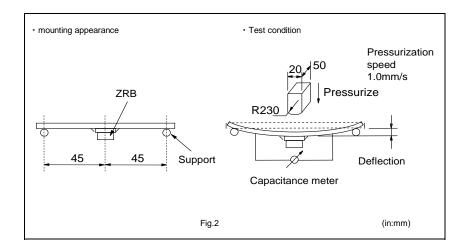
Tuno	Dimension (mm)				
Type	а	b	С		
ZRB18	1.0	3.0	1.2		

Adhesive Strength of Termination, Vibration Resistance,

Temperature Sudden Change, High Temperature High Humidity(Steady), Durability



Tuno	Dimension (mm)				
Туре	а	b	С		
ZRB18	1.0	3.0	1.2		





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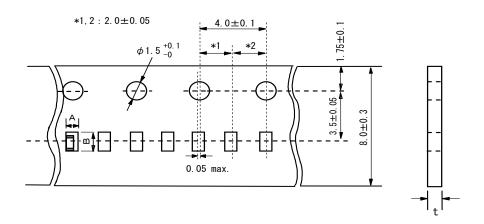
Package ZRB Type

- 1.Tape Carrier Packaging(Packaging Code:D/L)
- 1.1 Minimum Quantity(pcs./reel)

		φ180mm reel		
T	ype	Paper Tape	Plastic Tape	
		Code:D	Code:L	
ZRB15	Χ	8000		
ZRB18	Α		3000	

1.2 Dimensions of Tape (1)ZRB15

(in:mm)



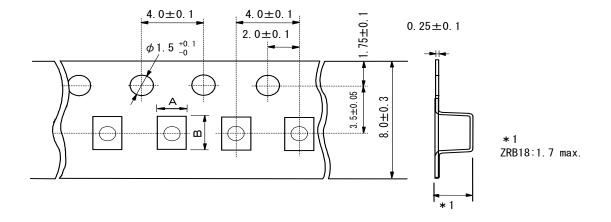
Code	ZRB15
A *3	0.8
B *3	1.3
t *3	0.95

*3 Nominal value



Package ZRB Type

(2)ZRB18 (in:mm)



Code	ZRB18
A *2	1.1
B *2	2.0

*2 Nominal value

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Package ZRB Type

(in:mm)

Fig.1 Package Chips

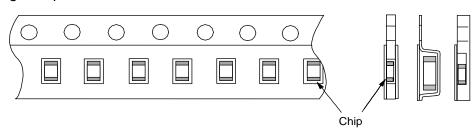


Fig.2 Dimensions of Reel

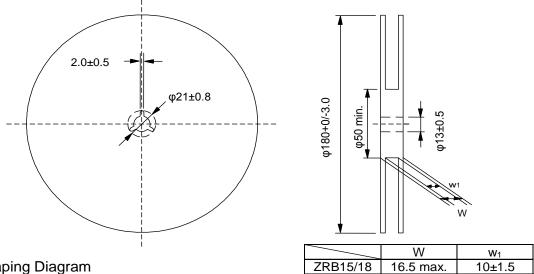
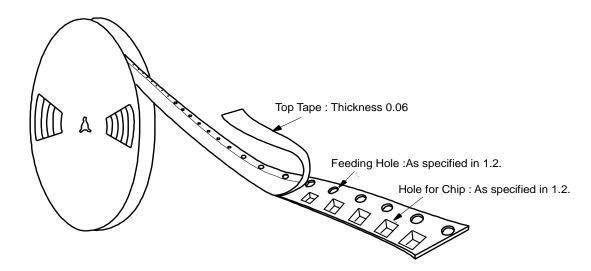


Fig.3 Taping Diagram



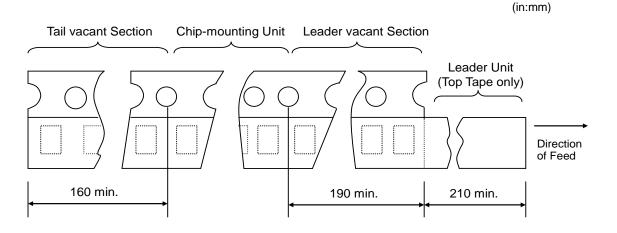
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Package ZRBType

1.3 Tapes for capacitors are wound clockwise shown in Fig.3. (The sprocket holes are to the right as the tape is pulled toward the user.)

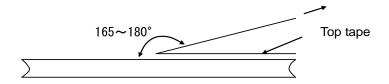
1.4 Part of the leader and part of the vacant section are attached as follows.



- 1.5 Accumulate pitch: 10 of sprocket holes pitch = 40 ± 0.3 mm
- 1.6 Chip in the tape is enclosed by top tape and bottom tape as shown in Fig.1.
- 1.7 The top tape and base tape are not attached at the end of the tape for a minimum of 5 pitches.
- 1.8 There are no jointing for top tape and bottom tape.
- 1.9 There are no fuzz in the cavity.
- 1.10 Break down force of top tape : 5N min.

 Break down force of bottom tape : 5N min. (Only a bottom tape existence)
- 1.11 Reel is made by resin and appeaser and dimension is shown in Fig 2.

 There are possibly to change the material and dimension due to some impairment.
- 1.12 Peeling off force: 0.1 to 0.6N in the direction as shown below.



1.13 Label that show the customer parts number, our parts number, our company name, inspection number and quantity, will be put in outside of reel.



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Limitation of use

Please contact our sales representatives or product engineers before using our products for the applications listed below which require of our products for other applications than specified in this product.

- ①Aircraft equipment ②Aerospace equipment ③Undersea equipment ④Power plant control equipment
- ⑤Medical equipment ⑥Transportation equipment(vehicles,trains,ships,etc.) ⑦Traffic signal equipment
- ®Disaster prevention / crime prevention equipment
 9Data-processing equipment

■ Storage and Operation condition

- 1. The performance of MLCC on Interposer (ZRB series) may be affected by the storage conditions.
- 1-1. Store capacitors in the following conditions: Temperature of +5°C to +40°C and a Relative Humidity of 20% to 70%.
- (1) Sunlight, dust, rapid temperature changes, corrosive gas atmosphere or high temperature and humidity conditions during storage may affect the solderability and the packaging performance Please use product within six months of receipt.
- (2) Please confirm solderability before using after six months. Store the capacitors without opening the original bag. Even if the storage period is short, do not exceed the specified atmospheric conditions.
- 1-2. Corrosive gas can react with the termination (external) electrodes or lead wires of capacitors, and result in poor solderability. Do not store the capacitors in an atmosphere consisting of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.).
- 1-3. Due to moisture condensation caused by rapid humidity changes, or the photochemical change caused by direct sunlight on the terminal electrodes and/or the resin/epoxy coatings, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or in high huimidity conditions

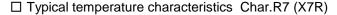
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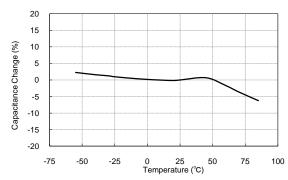
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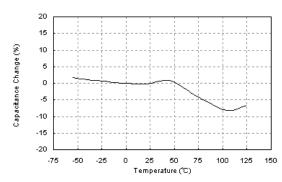
■ Rating

1.Temperature Dependent Characteristics

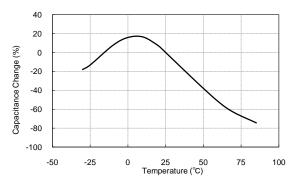
- 1. The electrical characteristics of the capacitor can change with temperature.
- 1-1. For capacitors having larger temperature dependency, the capacitance may change with temperature changes.
 - The following actions are recommended in order to insure suitable capacitance values.
 - (1) Select a suitable capacitance for the operating temperature range.
 - (2) The capacitance may change within the rated temperature.
 - When you use a high dielectric constant type capacitors in a circuit that needs a tight (narrow) capacitance tolerance.
 - Example: a time constant circuit., please carefully consider the characteristics of these capacitors, such as their aging, voltage, and temperature characteristics.
 - And check capacitors using your actual appliances at the intended environment and operating conditions.
- ☐ Typical temperature characteristics Char.R6 (X5R)







☐ Typical temperature characteristics Char.F5 (Y5V)



2.Measurement of Capacitance

- 1. Measure capacitance with the voltage and the frequency specified in the product specifications.
- 1-1. The output voltage of the measuring equipment may decrease when capacitance is high occasionally. Please confirm whether a prescribed measured voltage is impressed to the capacitor.
- 1-2. The capacitance values of high dielectric constant type capacitors change depending on the AC voltage applied.
 - Please consider the AC voltage characteristics when selecting a capacitor to be used in a AC circuit.

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3. Applied Voltage

- 1. Do not apply a voltage to the capacitor that exceeds the rated voltage as called-out in the specifications.
- 1-1. Applied voltage between the terminals of a capacitor shall be less than or equal to the rated voltage.
- (1) When AC voltage is superimposed on DC voltage, the zero-to-peak voltage shall not exceed the rated DC voltage.
 - When AC voltage or pulse voltage is applied, the peak-to-peak voltage shall not exceed the rated DC voltage.
- (2) Abnormal voltages (surge voltage, static electricity, pulse voltage, etc.) shall not exceed the rated DC voltage.

Typical voltage applied to the DC capacitor

DC voltage	DC voltage+AC	AC voltage	Pulse voltage
E	↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑ ↑	↑ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○	E O

(E: Maximum possible applied voltage.)

1-2. Influence of overvoltage

Overvoltage that is applied to the capacitor may result in an electrical short circuit caused by the breakdown of the internal dielectric layers .

The time duration until breakdown depends on the applied voltage and the ambient temperature.

4. Applied Voltage and Self-heating Temperature

- 1. When the capacitor is used in a high-frequency voltage, pulse voltage, application, be sure to take into account self-heating may be caused by resistant factors of the capacitor.
- 1-1. The load should be contained to the level such that when measuring at atomospheric temperature of 25°C, the product's self-heating remains below 20°C and surface temperature of the capacitor in the actual circuit remains within the maximum operating temperature.

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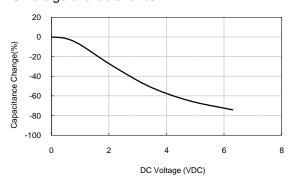
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5. DC Voltage and AC Voltage Characteristic

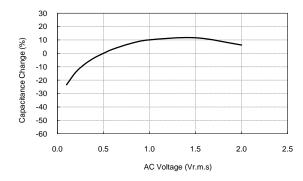
1. The capacitance value of a high dielectric constant type capacitor changes depending on the DC voltage applied.

Please consider the DC voltage characteristics when a capacitor is selected for use in a DC circuit.

- 1-1. The capacitance of ceramic capacitors may change sharply depending on the applied voltage. (See figure) Please confirm the following in order to secure the capacitance.
- (1) Whether the capacitance change caused by the applied voltage is within the range allowed or not.
- □ DC voltage characteristics
- (2) In the DC voltage characteristics, the rate of capacitance change becomes larger as voltage increases. Even if the applied voltage is below the rated voltage. When a high dielectric constant type capacitor is in a circuit that needs a tight (narrow) capacitance tolerance. Example: a time constant circuit., please carefully consider the characteristics of these capacitors, such as their aging, voltage, and temperature characteristics. And check capacitors using your actual appliances at the intended environment and operating conditions.



- 2. The capacitance values of high dielectric constant type capacitors change depending on the AC voltage applied. Please consider the AC voltage characteristics when selecting a capacitor to be used in a AC circuit.
 - ☐ AC voltage characteristics

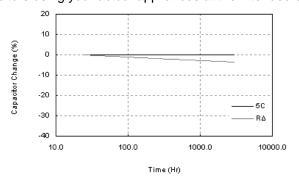


6. Capacitance Aging

1. The high dielectric constant type capacitors have the characteristic in which the capacitance value decreases with passage of time.

When you use a high dielectric constant type capacitors in a circuit that needs a tight (narrow) capacitance tolerance. Example: a time constant circuit., please carefully consider the characteristics of these capacitors, such as their aging, voltage, and temperature characteristics.

And check capacitors using your actual appliances at the intended environment and operating conditions.





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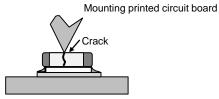
7. Vibration and Shock

- 1. Please confirm the kind of vibration and/or shock, its condition, and any generation of resonance.

 Please mount the capacitor so as not to generate resonance, and do not allow any impact on the terminals.
- 2. Mechanical shock due to falling may cause damage or a crack in the dielectric material of the capacitor. Do not use a fallen capacitor because the quality and reliability may be deteriorated.



3. When printed circuit boards are piled up or handled, the corners of another printed circuit board should not be allowed to hit the capacitor in order to avoid a crack or other damage to the capacitor.



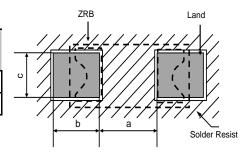
■ Soldering and Mounting

1.Mounting for MLCC on Interposer (ZRB series)

Please refer to the land dimensions in Table 1 for ZRB series.

(1)Recommended Land Dimensions

Table1 Land Dimensions							
Dimensions Part Number	LxW	а	р	С			
ZRB15	1.0×0.5	0.4~0.6	0.4~0.5	0.5~0.7			
ZRB18	1.6×0.8	0.7~0.9	0.7~0.8	0.8~1.0			
				(in mm)			



If distance between parts is too short, there is risk to cause electrical short.

Please confirm the mounting pitch (distance between centers of parts)

has 1.275mm or more. (ZRB18 only)

Please confirm the suitable mounting condition by evaluating of the actual SET / PCB.

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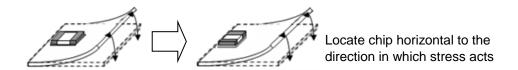


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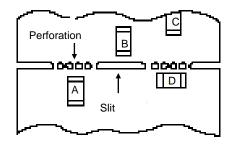
2.Mounting Position

- 1. Confirm the best mounting position and direction that minimizes the stress imposed on the capacitor during flexing or bending the printed circuit board.
- 1-1. Choose a mounting position that minimizes the stress imposed on the chip during flexing or bending of the board.

[Component Direction]



[Chip Mounting Close to Board Separation Point]



Chip arrangement Worst A-C-(B~D) Best

3.Information before mounting

- 1. Do Not re-use capacitors that were removed from the equipment.
- 2. Confirm capacitance characteristics under actual applied voltage.
- 3. Confirm the mechanical stress under actual process and equipment use.
- 4. Confirm the rated capacitance, rated voltage and other electrical characteristics before assembly.
- 5. Prior to use, confirm the Solderability for the capacitors that were in long-term storage.
- 6. Prior to measuring capacitance, carry out a heat treatment for capacitors that were in long-term storage.
- 7. The use of Sn-Zn based solder will deteriorate the reliability of the MLCC.

 Please contact our sales representative or product engineers on the use of Sn-Zn based solder in advance.

Datasheet of ZRB18AR61A106ME01L - CAP CER 10UF 10V X5R 0603

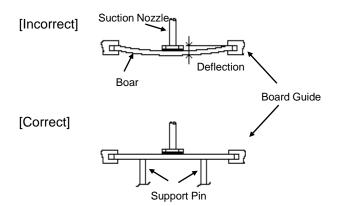
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4.Maintenance of the Mounting (pick and place) Machine

- 1. To adjust the inspection tolerance for automated appearance sorting machine of mounting position, because ZRB series are easier to shift the mounting position than standard MLCC.
- 2. To check the overturn and reverse of ZRB chip.
- 3. To control mounting speed carefully, because ZRB chip is heavier than standard MLCC.
- 4. Make sure that the following excessive forces are not applied to the capacitors.
- 4-1. In mounting the capacitors on the printed circuit board, any bending force against them shall be kept to a minimum to prevent them from any bending damage or cracking. Please take into account the following precautions and recommendations for use in your process.
- (1) Adjust the lowest position of the pickup nozzle so as not to bend the printed circuit board.
- (2) Adjust the nozzle pressure within a static load of 1N to 3N during mounting.



5.Dirt particles and dust accumulated between the suction nozzle and the cylinder inner wall prevent the nozzle from moving smoothly. This imposes greater force upon the chip during mounting, causing cracked chips. Also the locating claw, when worn out, imposes uneven forces on the chip when positioning, causing cracked chips. The suction nozzle and the locating claw must be maintained, checked and replaced periodically.

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5-1.Reflow Soldering

- 1. When sudden heat is applied to the components, the mechanical strength of the components will decrease because a sudden temperature change causes deformation inside the components. In order to prevent mechanical damage to the components, preheating is required for both the components and the PCB board. Preheating conditions are shown in table 1. It is required to keep the temperature differential between the solder and the components surface (ΔT) as small as possible.
- Solderability of Tin plating termination chips might be deteriorated when a low temperature soldering profile where the peak solder temperature is below the melting point of Tin is used. Please confirm the Solderability of Tin plated termination chips before use.
- 3. When components are immersed in solvent after mounting be sure to maintain the temperature difference (ΔT) between the component and the solvent within the range shown in the table 1.

Table 1

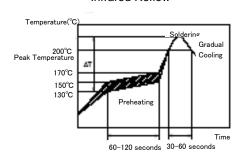
Part Number	Temperature Differential
ZRB15/ZRB18	ΔΤ≦190°C

Recommended Conditions

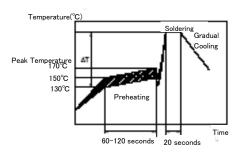
recommended conditions								
	Pb-Sn	Lead Free Solder						
	Infrared Reflow	Vapor Reflow	Lead Tree Solder					
Peak Temperature	230~250°C	230~240°C	240~260°C					
Atmosphere	Air	Air	Air or N ₂					

Lead Free Solder: Sn-3.0Ag-0.5Cu

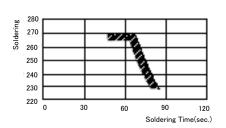
[Standard Conditions for Reflow Soldering] Infrared Reflow



Vapor Reflow



[Allowable Soldering Temperature and Time]



In case of repeated soldering, the accumulated soldering time must be within the range shown above.

5-2. Correction with a Soldering Iron

Correction with a soldering iron for ZRB chip may cause loss suppress acoustic noise, because the solder amount become excessive.

Do not correct with a soldering iron for ZRB series.

JEMCGC-02188B 16



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6.Washing

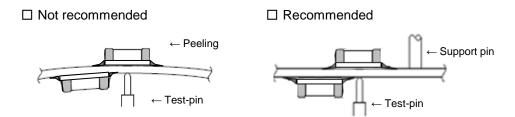
Excessive ultrasonic oscillation during cleaning can cause the PCBs to resonate, resulting in cracked chips or broken solder joints. Take note not to vibrate PCBs.

7.Electrical Test on Printed Circuit Board

- Confirm position of the support pin or specific jig, when inspecting the electrical performance of a capacitor after mounting on the printed circuit board.
- 1-1. Avoid bending printed circuit board by the pressure of a test pin, etc.

 The thrusting force of the test probe can flex the PCB, resulting in cracked chips or open solder joints.

 Provide support pins on the back side of the PCB to prevent warping or flexing.
- 1-2. Avoid vibration of the board by shock when a test pin contacts a printed circuit board.





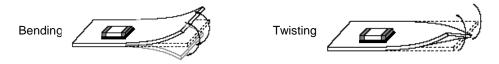
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△Caution

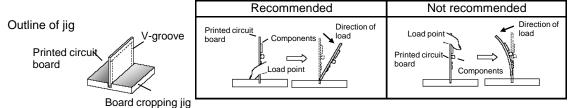
8. Printed Circuit Board Cropping

- 1. After mounting a capacitor on a printed circuit board, do not apply any stress to the capacitor that is caused by bending or twisting the board.
- 1-1. In cropping the board, the stress as shown right may cause the capacitor to crack. Try not to apply this type of stress to a capacitor.



- 2. Check of the cropping method for the printed circuit board in advance.
- 2-1. Printed circuit board cropping shall be carried out by using a jig or an apparatus to prevent the mechanical stress which can occur to the board.
 - (1) Example of a suitable jig

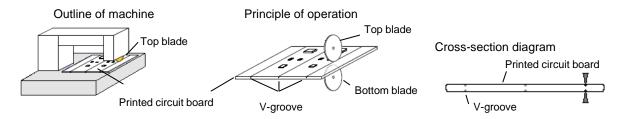
Recommended example: the board should be pushed as close to the near the cropping jig as possible and from the back side of board in order to minimize the compressive stress applied to capacitor. Not recommended example* when the board is pushed at a point far from the cropping jig and from the front side of board as below, the capacitor may form a crack caused by the tensile stress applied to capacitor.



(2) Example of a suitable machine

An outline of a printed circuit board cropping machine is shown as follows. Along the lines with the V-grooves on printed circuit board, the top and bottom blades are aligned to one another when cropping the board.

The misalignment of the position between top and bottom blades may cause the capacitor to crack.



	Recommended	Not recommended			
Recommended		Top-bottom misalignment	Left-right misalignment	Front-rear misalignment	
	Top blade	Top blade	Top blade	Top blade	
	Bottom blade	Bottom blade	Bottom blade	Bottom blade	



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△ Caution

■ Others

1. Under Operation of Equipment

- 1-1. Do not touch a capacitor directly with bare hands during operation in order to avoid the danger of a electric shock.
- 1-2. Do not allow the terminals of a capacitor to come in contact with any conductive objects (short-circuit). Do not expose a capacitor to a conductive liquid, inducing any acid or alkali solutions.
- 1-3. Confirm the environment in which the equipment will operation is under the specified conditions. Do not use the equipment under the following environment.
 - (1) Being spattered with water or oil.
 - (2) Being exposed to direct sunlight.
 - (3) Being exposed to Ozone, ultraviolet rays or radiation.
 - (4) Being exposed to toxic gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
 - (5) Any vibrations or mechanical shocks exceeding the specified limits.
 - (6) Moisture condensing environments.
- 1-4. Use damp proof countermeasures if using under any conditions that can cause condensation.

2. Others

2-1. In an Emergency

- (1) If the equipment should generate smoke, fire or smell, immediately turn off or unplug the equipment. If the equipment is not turned off or unplugged, the hazards may be worsened by supplying continuous power.
- (2) In this type of situation, do not allow face and hands to come in contact with the capacitor or burns may be caused by the capacitors high temperature.

2-2. Disposal of waste

When capacitors are disposed, they must be burned or buried by the industrial waste vender with the appropriate licenses.

2-3. Circuit Design

ZRB series in this product specification are not safety recognized products.

2-4. Remarks

Failure to follow the cautions may result, worst case, in a short circuit and smoking when the product is used.

The above notices are for standard applications and conditions. Contact us when the products are used in special mounting conditions.

Select optimum conditions for operation as they determine the reliability of the product after assembly. The data herein are given in typical values, not guaranteed ratings.



Datasheet of ZRB18AR61A106ME01L - CAP CER 10UF 10V X5R 0603

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Notice

Rating

1. Operating Temperature

- 1. The operating temperature limit depends on the capacitor.
- 1-1.Do not apply temperatures exceeding the upper operating temperature.
 - It is necessary to select a capacitor with a suitable rated temperature which will cover the operating temperature range.
 - Also it is necessary to consider the temperature distribution in equipment and the seasonal temperature variable factor.
- 1-2. Consider the self-heating of the capacitor
 - The surface temperature of the capacitor shall be the upper operating temperature or less when including the self-heating factors.

2.Atmosphere surroundings (gaseous and liquid)

- 1. Restriction on the operating environment of capacitors.
- 1-1. The capacitor, when used in the above, unsuitable, operating environments may deteriorate due to the corrosion of the terminations and the penetration of moisture into the capacitor.
- 1-2. The same phenomenon as the above may occur when the electrodes or terminals of the capacitor are subject to moisture condensation.
- 1-3. The deterioration of characteristics and insulation resistance due to the oxidization or corrosion of terminal electrodes may result in breakdown when the capacitor is exposed to corrosive or volatile gases or solvents for long periods of time.

3.Piezo-electric Phenomenon

1. When using high dielectric constant type capacitors in AC or pulse circuits, the capacitor itself vibrates at specific frequencies and noise may be generated.

Moreover, when the mechanical vibration or shock is added to capacitor, noise may occur.



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Notice

Soldering and Mounting

1.PCB Design

- 1. Notice for Pattern Forms
- 1-1.There is a possibility of chip crack caused by PCB expansion/contraction with heat.
 Because stress for chip is different depend on PCB material and structure. Especially metal PCB such as alumina has a greater risk of chip crack because of large difference of thermal expansion coefficient.

2.Washing

- 1. Please evaluate a capacitor by actual cleaning equipment and condition surely for confirming the quality and select the applicable solvent.
- 2. Unsuitable cleaning solvent may leave residual flux, other foreign substances, causing deterioration of electrical characteristics and the reliability of the capacitors.
- 3. Select the proper cleaning conditions.
- 3-1. Improper cleaning conditions (excessive or insufficient) may result in the deterioration of the performance of the capacitors.

3.Coating

Loss suppress acoustic noise may be caused in ZRB chip due to the resin during curing process.
 Please contact our sales representative or product engineers on the apply to resin during curing process.



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Notice

Others

1.Transportation

- 1. The performance of a capacitor may be affected by the conditions during transportation.
- 1-1. The capacitors shall be protected against excessive temperature, humidity and mechanical force during transportation.
 - (1) Climatic condition
 - ─ low air temperature : ─40°C
 - change of temperature air/air : -25°C/+25°C
 - low air pressure : 30 kPa
 - change of air pressure : 6 kPa/min
- (2) Mechanical condition

Transportation shall be done in such a way that the boxes are not deformed and forces are not directly passed on to the inner packaging.

- 1-2. Do not apply excessive vibration, shock, and pressure to the capacitor.
- (1) When excessive mechanical shock or pressure is applied to a capacitor, chipping or cracking may occur in the ceramic body of the capacitor.
- (2) When a sharp edge of an air driver, a soldering iron, tweezers, a chassis, etc. impacts strongly on the surface of capacitor, the capacitor may crack and short-circuit.
- 1-3. Do not use a capacitor to which excessive shock was applied by dropping etc.

 The capacitor dropped accidentally during processing may be damaged.



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igwedge NOTE

- Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. Your are requested not to use our product deviating from this product specification.
- 3.We consider it not appropriate to include any terms and conditions with regard to the business transaction in the product specifications, drawings or other technical documents. Therefore, if your technical documents as above include such terms and conditions such as warranty clause, product liability clause, or intellectual property infringement liability clause, they will be deemed to be invalid.